

SOT-23 Plastic-Encapsulate MOSFETS

BSS84 P-CHANNEL MOSFET

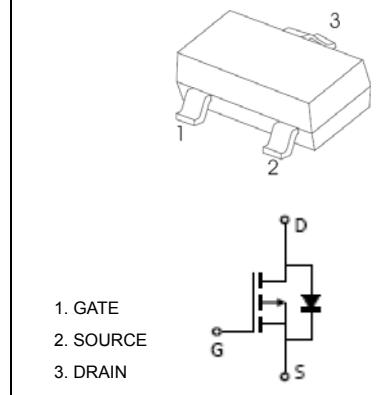
DESCRIPTION

These miniature surface mount MOSFETs reduce power loss conserve energy, making this device ideal for use in small power management circuitry.

FEATURE

- Energy Efficient
- Low Threshold Voltage
- High-speed Switching
- Miniature Surface Mount Package Saves Board Space

SOT-23



APPLICATION

- DC-DC converters, load switching, power management in portable and battery-powered products such as computers, printers, cellular and cordless telephones.

MARKING: B84

MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-0.13	A
Pulsed Drain Current (note 1) @ $t_p < 10 \mu\text{s}$	I_{DM}	-0.52	A
Power Dissipation	P_D	225	mW
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	556	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C
Maximum Lead Temperature for Soldering Purposes , Duration for 5 Seconds	T_L	260	°C

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
STATIC CHARACTERISTICS						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-50			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -50\text{V}, V_{\text{GS}} = 0\text{V}$			-15	μA
		$V_{\text{DS}} = -25\text{V}, V_{\text{GS}} = 0\text{V}$			-0.1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 5	μA
Gate threshold voltage (note 3)	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.9		-2	V
Drain-source on-resistance (note 3)	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -5\text{V}, I_D = -0.1\text{A}$			10	Ω
		$V_{\text{GS}} = -10\text{V}, I_D = -0.1\text{A}$			8	Ω
Forward transconductance (note 1)	g_{FS}	$V_{\text{DS}} = -25\text{V}; I_D = -100\text{mA}$	50			mS
DYNAMIC CHARACTERISTICS (note 4)						
Input capacitance	C_{iss}	$V_{\text{DS}} = 5\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		30		pF
Output capacitance	C_{oss}			10		pF
Reverse transfer capacitance	C_{rss}			5		pF
SWITCHING CHARACTERISTICS (note 4)						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, R_L = 50\Omega, I_D = -2.5\text{A}$		2.5		ns
Turn-on rise time	t_r			1		ns
Turn-off delay time	$t_{\text{d}(\text{off})}$			16		ns
Turn-off fall time	t_f			8		ns
SOURCE-DRAIN DIODE CHARACTERISTICS						
Continuous Current	I_S				-0.13	A
Pulsed Current	I_{SM}				-0.52	A
Diode forward voltage (note 3)	V_{DS}	$I_S = -0.13\text{A}, V_{\text{GS}} = 0\text{V}$			-2.2	V

Notes :

1. Repetitive rating : Pulse width limited by junction temperature.
2. Surface mounted on FR4 board , $t \leq 10\text{s}$.
3. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to producting.